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FDMA1024NZ

Dual N-Channel PowerTrench[®] MOSFET

20 V, 5.0 A, 54 mΩ

Features

- Max $r_{DS(on)}$ = 54 mΩ at V_{GS} = 4.5 V, I_D = 5.0 A
- Max $r_{DS(on)}$ = 66 mΩ at V_{GS} = 2.5 V, I_D = 4.2 A
- Max $r_{DS(on)}$ = 82 mΩ at V_{GS} = 1.8 V, I_D = 2.3 A
- Max $r_{DS(on)}$ = 114 mΩ at V_{GS} = 1.5 V, I_D = 2.0 A
- HBM ESD protection level = 1.6 kV (Note 3)
- Low profile - 0.8 mm maximum - in the new package MicroFET 2x2 mm
- RoHS Compliant
- Free from halogenated compounds and antimony oxides



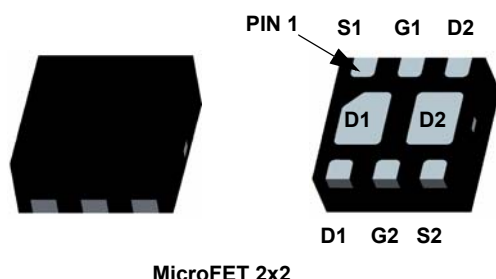
General Description

This device is designed specifically as a single package solution for dual switching requirements in cellular handset and other ultra-portable applications. It features two independent N-Channel MOSFETs with low on-state resistance for minimum conduction losses.

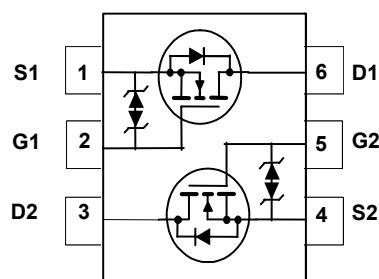
The MicroFET 2X2 package offers exceptional thermal performance for its physical size and is well suited to linear mode applications.

Applications

- Baseband Switch
- Loadswitch
- DC-DC Conversion



MicroFET 2x2



MOSFET Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DS}	Drain to Source Voltage	20	V
V_{GS}	Gate to Source Voltage	±8	V
I_D	Drain Current -Continuous	5.0	A
	-Pulsed	6.0	
P_D	Power Dissipation	1.4	W
	Power Dissipation	0.7	
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	86 (Single Operation)	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	173 (Single Operation)	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1c)	69 (Dual Operation)	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1d)	151 (Dual Operation)	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
024	FDMA1024NZ	MicroFET 2X2	7"	8 mm	3000 units

Electrical Characteristics $T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Off Characteristics

BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250\text{ }\mu\text{A}$, $V_{GS} = 0\text{ V}$	20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250\text{ }\mu\text{A}$, referenced to $25\text{ }^{\circ}\text{C}$		19		mV/ $^{\circ}\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 16\text{ V}$, $V_{GS} = 0\text{ V}$			1	μA
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8\text{ V}$, $V_{DS} = 0\text{ V}$			± 10	μA

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250\text{ }\mu\text{A}$	0.4	0.7	1.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250\text{ }\mu\text{A}$, referenced to $25\text{ }^{\circ}\text{C}$		-3		mV/ $^{\circ}\text{C}$
$r_{DS(on)}$	Static Drain to Source On-Resistance	$V_{GS} = 4.5\text{ V}$, $I_D = 5.0\text{ A}$		37	54	m Ω
		$V_{GS} = 2.5\text{ V}$, $I_D = 4.2\text{ A}$		43	66	
		$V_{GS} = 1.8\text{ V}$, $I_D = 2.3\text{ A}$		52	82	
		$V_{GS} = 1.5\text{ V}$, $I_D = 2.0\text{ A}$		67	114	
		$V_{GS} = 4.5\text{ V}$, $I_D = 5.0\text{ A}$, $T_J = 125\text{ }^{\circ}\text{C}$		51	75	
g_{FS}	Forward Transconductance	$V_{DD} = 5\text{ V}$, $I_D = 5.0\text{ A}$		16		S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 10\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 1\text{ MHz}$		375	500	pF
C_{oss}	Output Capacitance			70	95	pF
C_{rss}	Reverse Transfer Capacitance			40	65	pF
R_G	Gate Resistance	$f = 1\text{ MHz}$		4.3		Ω

Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 10\text{ V}$, $I_D = 5.0\text{ A}$ $V_{GS} = 4.5\text{ V}$, $R_{GEN} = 6\text{ }\Omega$		5.3	11	ns
t_r	Rise Time			2.2	10	ns
$t_{d(off)}$	Turn-Off Delay Time			18	33	ns
t_f	Fall Time			2.3	10	ns
Q_g	Total Gate Charge	$V_{GS} = 4.5\text{ V}$, $V_{DD} = 10\text{ V}$, $I_D = 5.0\text{ A}$		5.2	7.3	nC
Q_{gs}	Gate to Source Gate Charge			0.6		nC
Q_{gd}	Gate to Drain "Miller" Charge			0.9		nC

Drain-Source Diode Characteristics

I_S	Maximum Continuous Source-Drain Diode Forward Current				1.1	A
V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0\text{ V}$, $I_S = 1.1\text{ A}$ (Note 2)		0.7	1.2	V
t_{rr}	Reverse Recovery Time	$I_F = 5.0\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$		19	35	ns
Q_{rr}	Reverse Recovery Charge			5	10	nC

Notes:

1. $R_{\theta JA}$ is determined with the device mounted on a 1 in² oz. copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta JA}$ is determined by the user's board design.

(a) $R_{\theta JA} = 86\text{ }^{\circ}\text{C/W}$ when mounted on a 1 in² pad of 2 oz copper, 1.5 " x 1.5 " x 0.062 " thick PCB. For single operation.

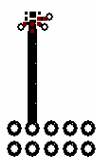
(b) $R_{\theta JA} = 173\text{ }^{\circ}\text{C/W}$ when mounted on a minimum pad of 2 oz copper. For single operation.

(c) $R_{\theta JA} = 69\text{ }^{\circ}\text{C/W}$ when mounted on a 1 in² pad of 2 oz copper, 1.5 " x 1.5 " x 0.062 " thick PCB. For dual operation.

(d) $R_{\theta JA} = 151\text{ }^{\circ}\text{C/W}$ when mounted on a minimum pad of 2 oz copper. For dual operation.



a) 86 $^{\circ}\text{C/W}$ when mounted on a 1 in² pad of 2 oz copper.



b) 173 $^{\circ}\text{C/W}$ when mounted on a minimum pad of 2 oz copper.



c) 69 $^{\circ}\text{C/W}$ when mounted on a 1 in² pad of 2 oz copper.



d) 151 $^{\circ}\text{C/W}$ when mounted on a minimum pad of 2 oz copper.

2. Pulse Test : Pulse Width < 300 us, Duty Cycle < 2.0 %

3: The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

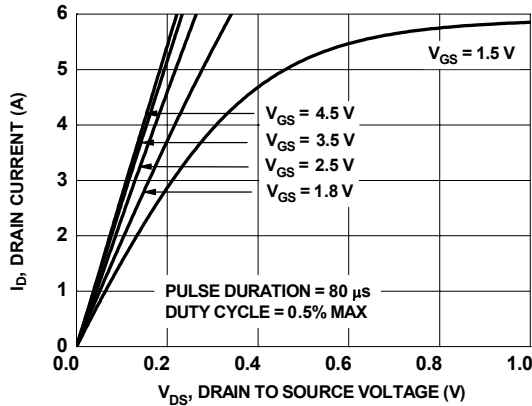


Figure 1. On-Region Characteristics

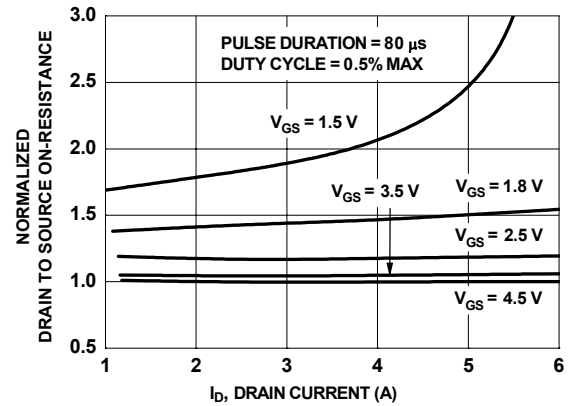


Figure 2 Normalized On-Resistance vs Drain Current and Gate Voltage

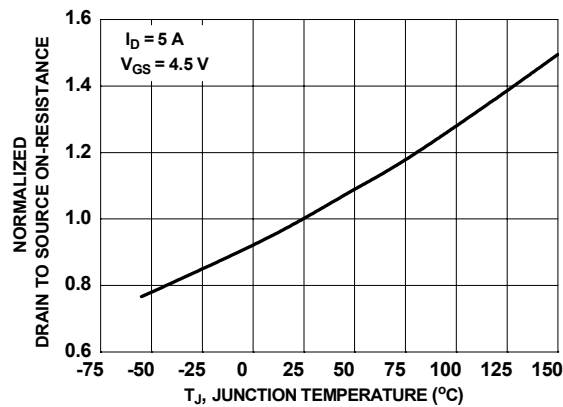


Figure 3. Normalized On-Resistance vs Junction Temperature

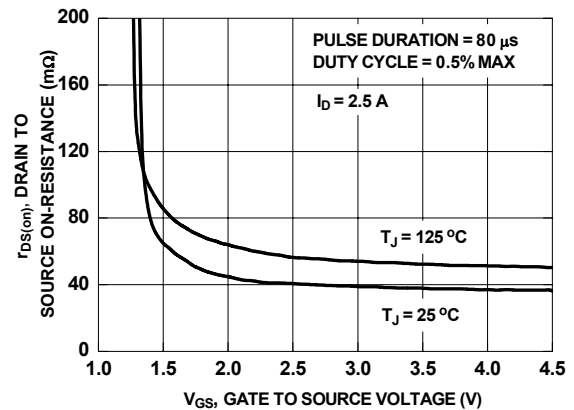


Figure 4. On-Resistance vs Gate to Source Voltage

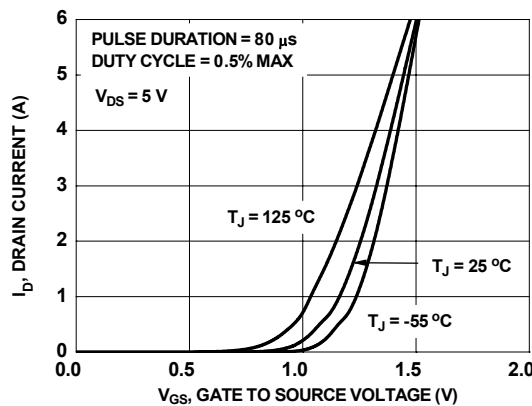


Figure 5. Transfer Characteristics

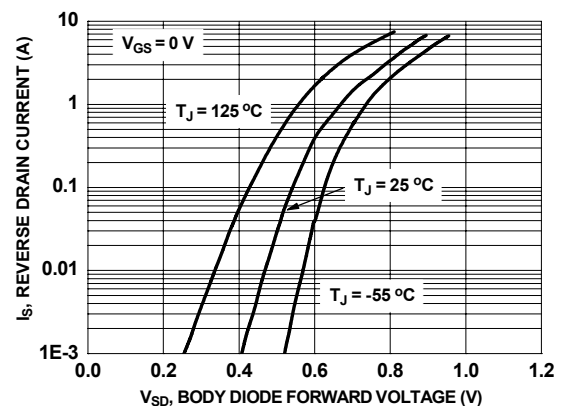


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

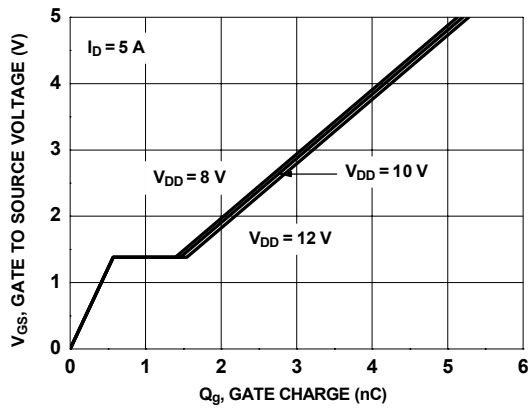


Figure 7. Gate Charge Characteristics

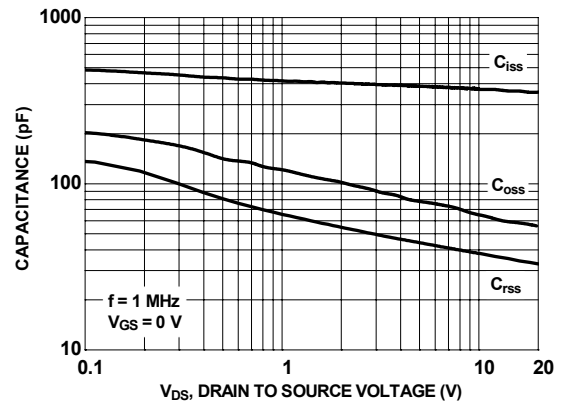


Figure 8. Capacitance vs Drain to Source Voltage

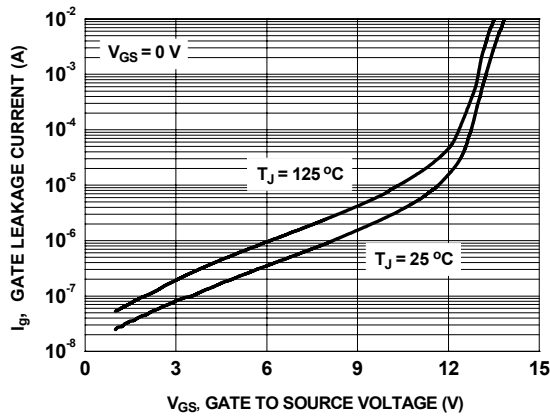


Figure 9. Gate Leakage Current vs Gate to Source Voltage

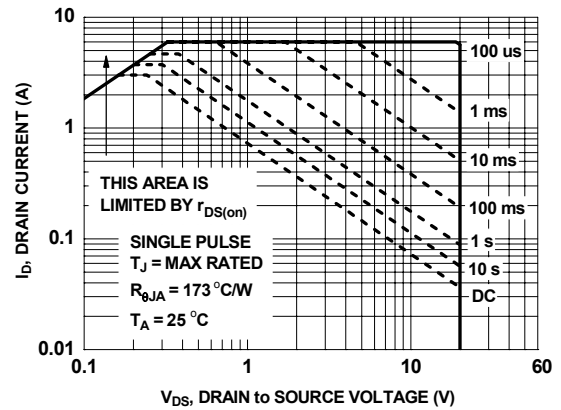


Figure 10. Forward Bias Safe Operating Area

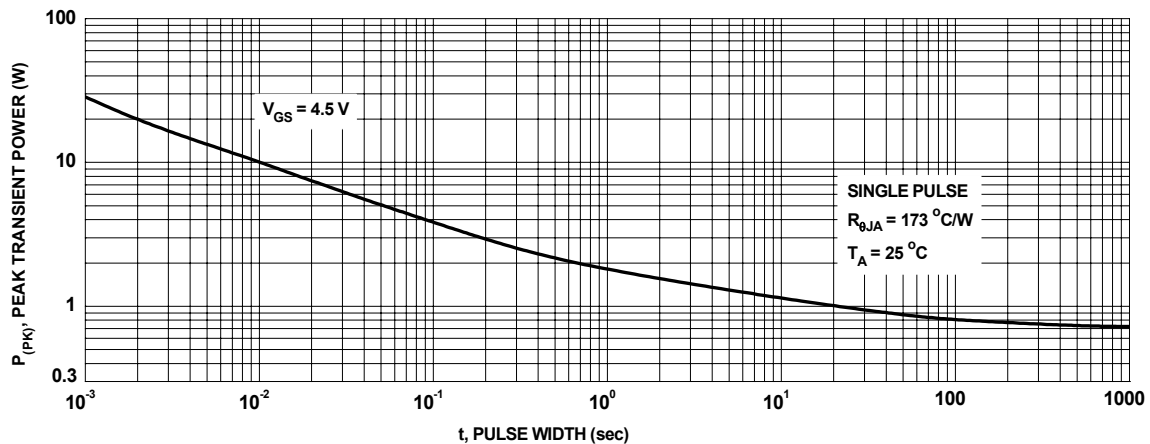
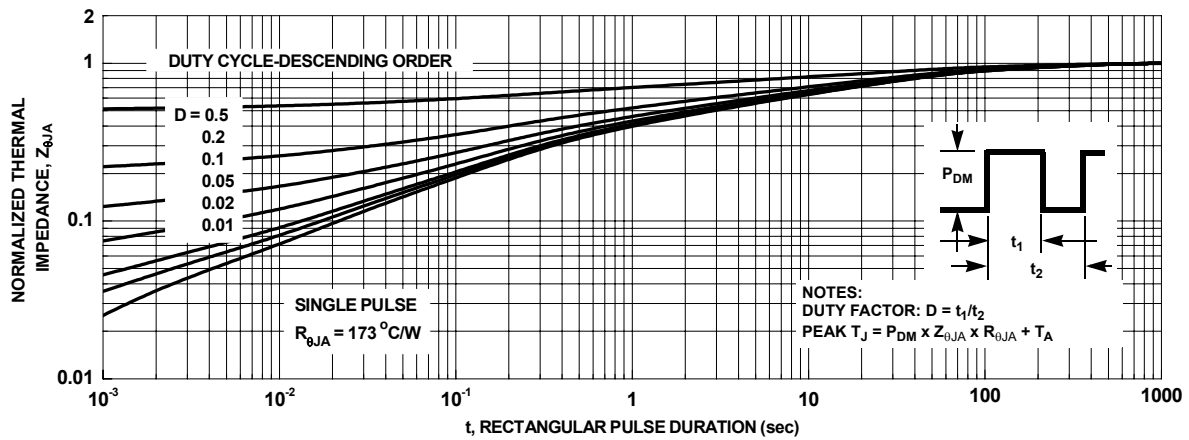
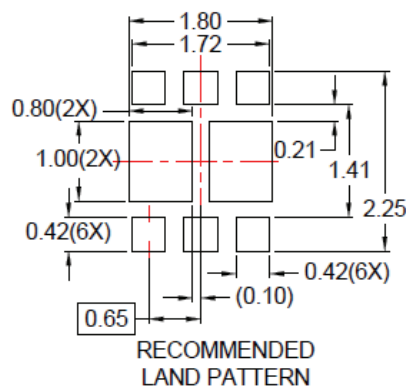
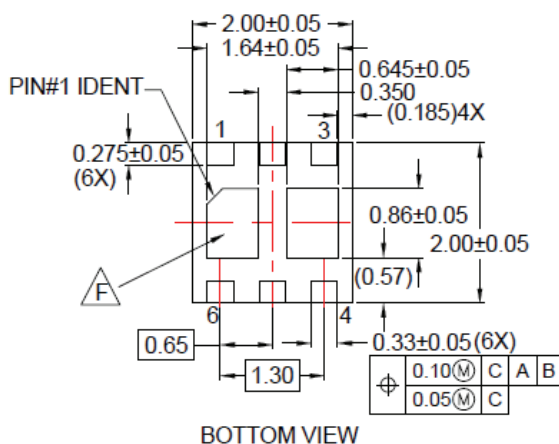
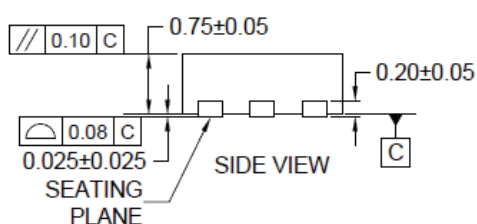
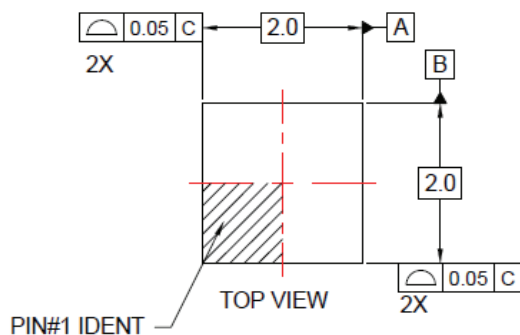


Figure 11. Single Pulse Maximum Power Dissipation

Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted



Dimensional Outline and Pad Layout



NOTES:

- CONFORM TO JEDEC REGISTRATIONS MO-229, VARIATION VCCC, EXCEPT WHERE NOTED.
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- DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- DRAWING FILENAME: MKT-UMLP16Erev4
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